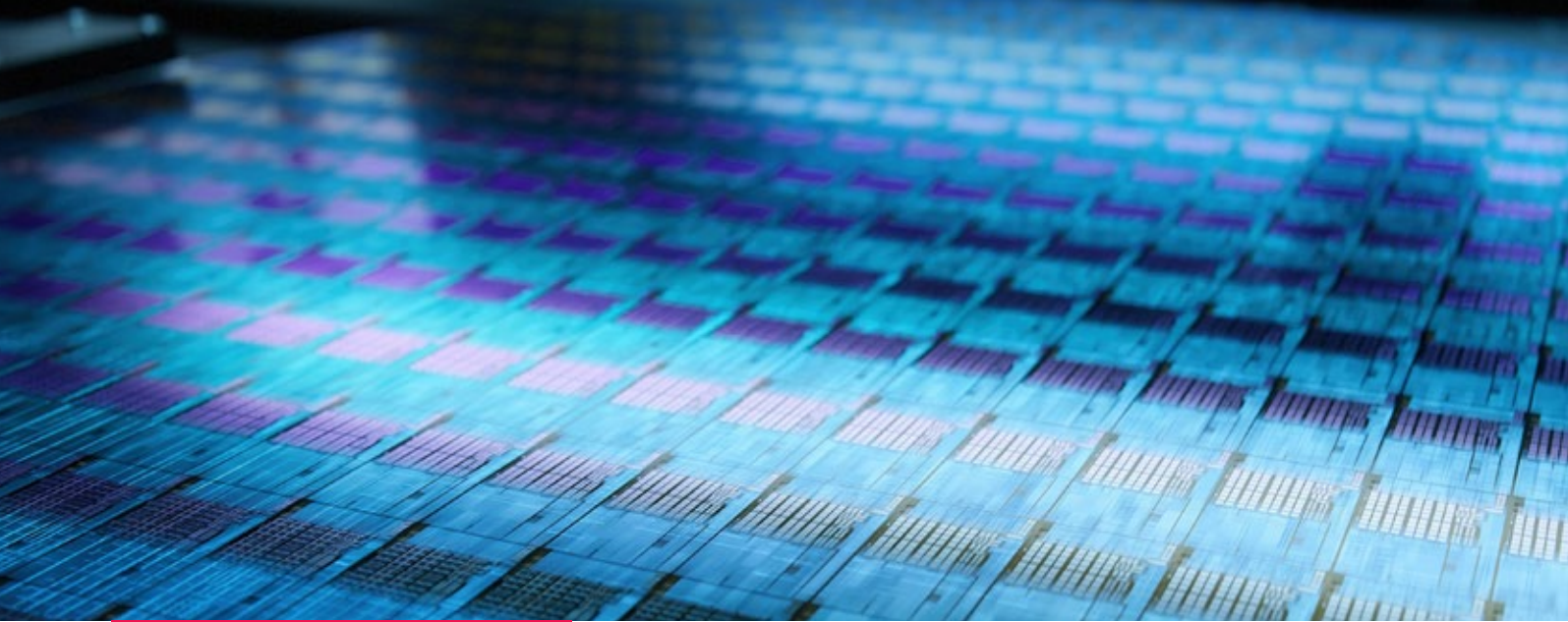




S E M I C O N

**Advanced Ceramic
Solutions for the
Semiconductor
Industry**



Ceram Tec – customized solutions for demanding semiconductor applications

CeramTec advanced ceramics with their unique material properties such as resistance, homogeneity and reliability open up enormous performance potential for a large variety of industries and applications.

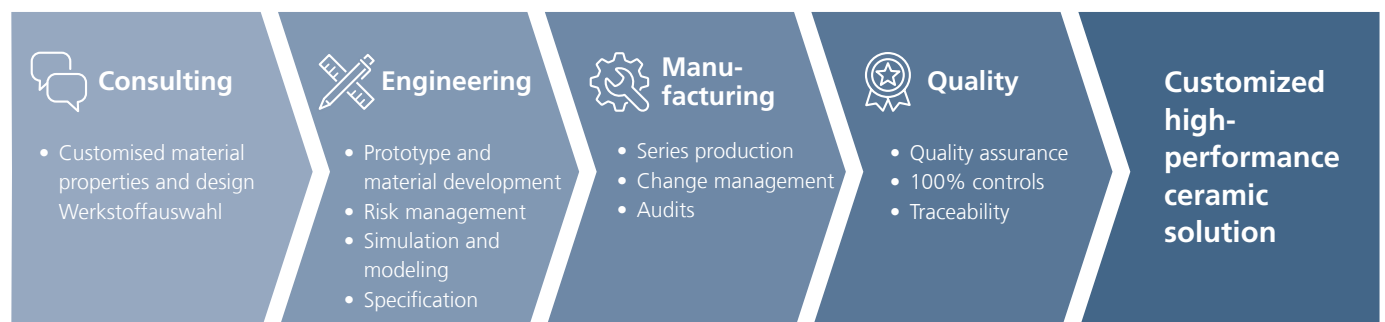
Over 120 years of experience in technical ceramics and many years of experience in the semiconductor industry, combined with comprehensive material and process know-how and outstanding product characteristics make us one of the key go-to solution partners, when it comes to ceramic components utilized in the semiconductor

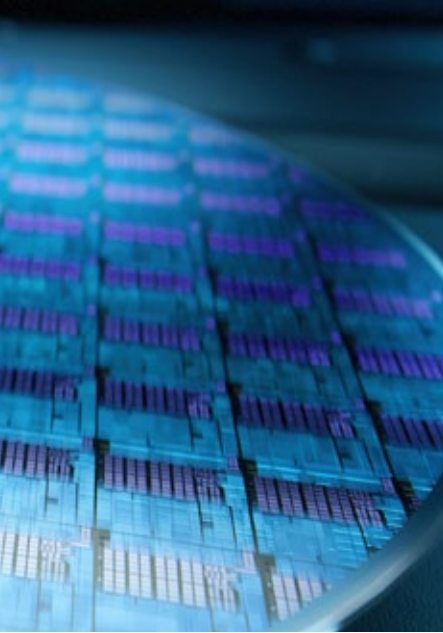
industry. These ceramics are characterized by harsh processing environments, must withstand tough conditions and require long lasting functional performance and reliability.

CeramTec offers solutions meeting all these requirements: tailor-made from high-purity advanced ceramics and perfectly implemented according to your individual needs!

From the initial idea to the final product

Agile and flexible cooperation along the entire process chain





Advanced ceramics meeting highest demands - indispensable for the semiconductor business

Discover the advantages offered by our advanced ceramics portfolio and benefit from our solution expertise for a variety of handling and manufacturing processes in the semiconductor industry. We develop our ceramic

components and parts according to your individual application requirements, so you can design and maintain your processes flexibly and reliably.



The optimal solution for your needs

Because we see ourselves not only as a pure manufacturer of high-quality ceramic semiconductor components, but rather as a strong development partner who transform your requirements into individual solutions: with state of the art products, in almost any desired geometry and design, with the corresponding material properties, vertical range of manufacture and optimum functionality.

Our material is your success

Whether in wafer processing, semiconductor manufacturing or handling - our components made of high-performance ceramics enable long lasting performance and reliability. CeramTec offers the right ceramic for every requirement:

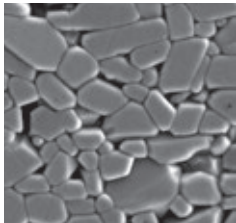
- Al_2O_3 – high purity and rigidity
- AlN – high thermal conductivity and electrical insulation
- SiSiC – low thermal expansion and density
- Si_3N_4 – high fracture toughness and low thermal expansion

Exemplary CeramTec components for the semiconductor industry

Discover our solution expertise for a wide range of semiconductor applications and benefit from outstanding material properties and individual design.

Alumina - Rubalit

Products	Material benefits
<ul style="list-style-type: none">• Wafer Polishing Plates• End Effectors / Wafer-Handling• Metalised Products• Chamber Rings / Sputtering Targets	<ul style="list-style-type: none">• High rigidity• High thermal resistance• Surface shape / roughness control

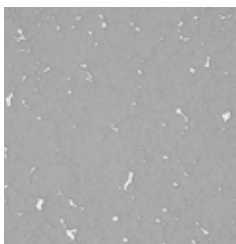


Microstructure
Rubalit

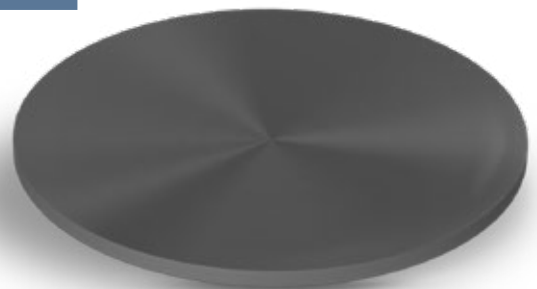


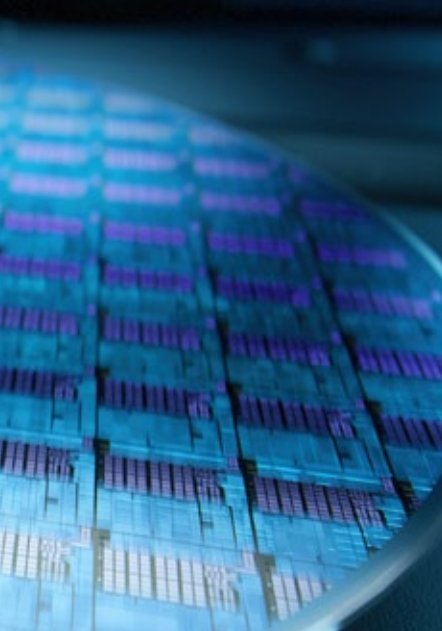
Silicon carbide – ROCAR

Products	Material benefits
<ul style="list-style-type: none">• Wafer Polishing Plates• Electrostatic Chucks• Vacuum Chucks• End Effectors / Wafer-Handling• Chamber Rings	<ul style="list-style-type: none">• High thermal conductivity• Low thermal expansion• High rigidity• Good chemical resistance• Variety of surface finishes



Microstructure ROCAR
(SiSiC)





ROCAR 3D – design freedom meets optimum material properties

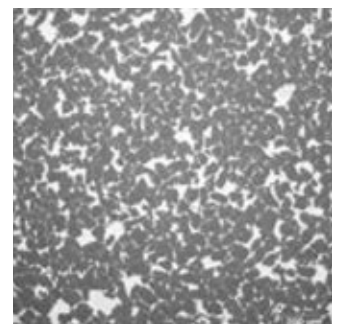
Experience complete design freedom with silicon carbide (SiSiC), a unique material in one of the most innovative manufacturing processes of our time: 3D printing. Together with us you can create lightweight structural and functional parts, reduced in their design to include only absolutely necessary elements. Get your finished parts faster without time- and cost-intensive processing steps such as green machining, milling and joining and enhance further cost-saving potential through component optimization. With material thicknesses from 2 mm to 35 mm and hole diameters from 2 mm, you have a diverse range of design options at your disposal.

Unbeatable process advantages of 3D printing:

- + Print directly from CAD data
- + No milling necessary, therefore lower tool costs
- + Cavities and undercuts possible
- + Short production lead and tooling times
- + Maximum flexibility: make design changes with a mouse click
- + Printing of inline channels possible
- + Simultaneous production of several components on one 3D printer



*ROCAR 3D microstructure
Maximum homogeneity: the
layer structure is no longer
detectable in the microstructure.*



CeramTec
THE CERAMIC EXPERTS

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